



I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231

By: Date: December 11, 2002IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Roland Rupp et al.

Applic. No. : 09/630,154

Filed : July 31, 2000

Title : Device for Mounting a Substrate and Method  
for Producing an Insert for a Susceptor

Examiner : Ram N. Kackar

Group Art Unit : 1763

A M E N D M E N THon. Commissioner of Patents and Trademarks,  
Washington, D. C. 20231

RECEIVED  
DEC 18 2003  
TC 1700 MAIL ROOM

Sir:

Responsive to the Office action dated September 11, 2002,  
kindly amend the above-identified application as follows:

In the Claims:

A' Claim 6 (Amended). The device according to claim 1, wherein  
said portion of said surface serves for mounting the  
substrate, and said given thickness of said metal carbide  
layer decreases with an increasing distance from said portion  
of said surface. B